ASSOCIATION CONNECT	© Copyright 2005. IP	Material Composition Declaration © Copyright 2005. IPC, Bannockburn, Illinois. All rights reserved under both international and Pan-American copyright conventions.				This document is a declaration of the substances within the manufacturer listed item. Note: if the item is an assembly with lower level parts, the declaration encompasses all lower level materials for which the manufacturer has engineering responsibility.										
752-21.1		IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute									us Materia	ials and Mfg Information				
Supplier Infor	mation						·									
Company name*			Company un	Company unique ID			Unique ID Authority					Response Date*				
onsemi												2024-05-17				
Contact Name		Title - Contact			F	Phone - Contact*					Email - Contact*					
Product-Env-Ste	wards	Product Enviro Compliance]	NA					Product-Env-Stewards@onsemi.com					
uthorized Repre	esentative*	Title - Representative			F	Phone - Representative*				Email - Representative*						
Product-Env-Stewards			Product Enviro Compliance]	NA				Product-Env-Stewards@onsemi.com					
Reque	ster Item Number			em Number Mfr Item Name			Effective Dat	e Versio	Version Manufacturing Site		g Site	W	eight*	UOM	Unit Type	
				I2C Auto Transla	Translator		2024-05-17 TH2			3.456		mg	Each			
Ianufacturin	g Proccess Informati	on														
Termin	al Plating / Grid Array Material		Terminal Base Alloy		J-STD-020 M	SL Rating	Peak Pro	Peak Process Body Temperature		e Max Time at Peak Temper		Temperatu	ature Number of Reflow Cycles		eles	
Preciou Sn)			CU Alloy 1		1		260		С	30	seco		s 3			
Comments																
vel 1 - maximun	n time at peak temperatur	e during so	oldering is 10-3	30 seconds												
or more informa	ation regarding material c	omposition	please refer to	page 3												

RoHS Material Composition Declaration			Declaration Type *	Detail	ed						
Directive 2015/863/EU amending RoHS Directive 2011/65/EU RoHS Definition: Quantity limit of 0.01% by mass (100 PPM) in homogeneous material for Cadmium and quantity limit of 0.1% by mass (1000 PPM) in homogeneous material for: Lead (Pb), Mercury (Hg), Hexavalent Chromium (Cr6+), Polybrominated Biphenyls (PBB), Polybrominated Diphenyl Ethers (PBDE), and Bis(2-ethylhexyl) phthalate (DEHP), Benzyl-butyl phthalate (BBP), Dibutyl phthalate (DBP), Diisobutyl phthalate (DIBP).											
Please indicate whether any homogeneous material (as defined by the RoHS Directive, EU 2011/65/EU and implemented by the laws of the European Union member states) of the part identified on this form contains lead, mercury, cadmium, hexavalentchromium, polybrominated biphenyls and/or polybrominated diphenyl ethers (each a "RoHS restricted substance") in excess of the applicable quantity limit identified above. If a homogeneous material within the part contains a RoHS restricted substance inexcess of an applicable quantity limit, please indicate below which, if any, RoHS exemption you believe may apply. If the part is an assembly with lower level components, the declaration shall encompass all such components. Supplier certifies that it gathered the information is true and correct to the best of its knowledge and belief, as of the date that Supplier completes this form. Supplier acknowledges that Company will rely on this certification in determining the compliance of its products with European Union member state laws that implement the RoHS Directive. Company acknowledges that Supplier may have relied on information provided by others in completing this form, and that Supplier may not have independently verified such information. However, in situations where Supplier have provided certifications regarding their contributions to the part, and those certifications are at least as comprehensive as the certification in this paragraph. If the Company and the Supplier enter into a written agreement with respect to the identified part, the terms and conditions of that agreement, including any warranty rights and/or remedies provided as part of that agreement, will be the sole and exclusivesource of the Supplier's liability and the Company's remedies for issues that arise regarding information the Supplier provides in this form. In the absence of such written agreement, the warranty rights and/or remedies of Supplier's Standard Terms and Conditions of Sale applicable to such part shall apply.											
RoHS Declaration * 1 - Item	(s) does not contain RoHS restricted substar	nces per the definition above	Supplier A	cceptance *	Accepted						
Exemption: If the declared item does not contain RoHS restricted substances per the definition above except for defined RoHS exemptions, then select the corresponding response in the RoHS Declaration above and choose all applicable exemptions.											
Exemption List Version	EL-2011/534/EU										
Declaration Signature											
		e "Accepted" on the Supplier Acceptance	drop-down. This will display the signature a	rea. Digitally sign t	the declaration (if required by the						

Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Substance Instructions: [A] select the Level (JIG A, JIG B, Requester or Supplier) [B] select the substance category (JIG or Requester) or enter a value (Supplier). [C] select the substance (JIG) or enter the substance and CAS (Other). [D] select a RoHS exemption, if applicable [E] enter the weight of the substance or the PPM concentration [F] Optionally enter the positive (+) and negative (-) tolerance in percent (Note: percent tolerance values are expected to cover a 3 sigma range of distribution unless otherwise noted).

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die	0.148	mg	Supplier	Silicon (Si)	7440-21-3		0.148	mg
Die Attach Epoxy	0.015	mg		Epoxy resin	proprietary data		0.0097	mg
			Supplier	Aluminum Trioxide (Al2O3)	1344-28-1		0.0052	mg
Lead Frame	1.034	mg	Supplier	Magnesium (Mg)	7439-95-4		0.0018	mg
			Supplier	Silicon (Si)	7440-21-3		0.0077	mg
			В	Nickel (Ni)	7440-02-0		0.0336	mg
			Supplier	Copper (Cu)	7440-50-8		0.991	mg
Mold Compound-Black	2.225		Supplier	Carbon Black (C)	1333-86-4		0.0111	mg
			Supplier	Fused Silica (SiO2)	60676-86-0		1.958	mg
			Supplier	Ortho-Cresol Novolac Resin	29690-82-2		0.1446	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		0.1112	mg
Plating	0.015	mg	Supplier	Palladium (Pd)	7440-05-3		0.0011	mg
			В	Nickel (Ni)	7440-02-0		0.0137	mg
			Supplier	Gold (Au)	7440-57-5		0.0002	mg
Wire Bond - Au	0.019	mg	Supplier	Gold (Au)	7440-57-5		0.019	mg